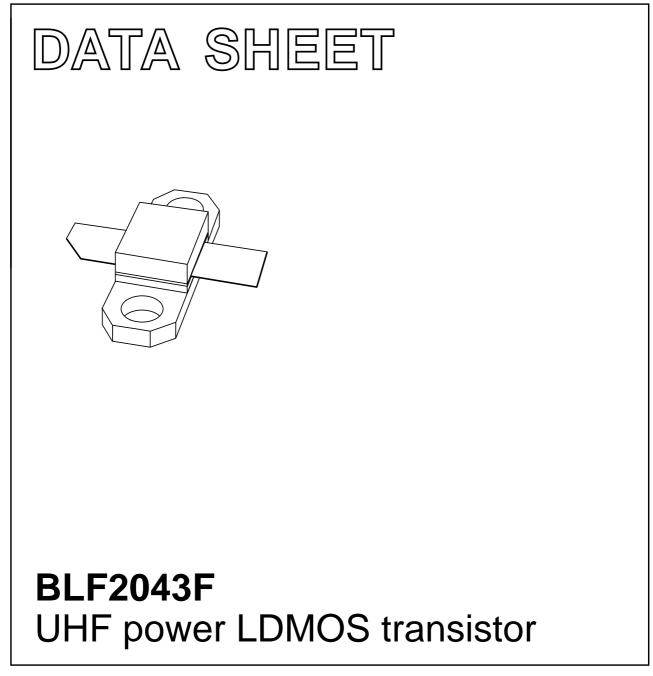
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2000 Oct 19 2002 Mar 05



FEATURES

- High power gain
- · Easy power control
- Excellent ruggedness
- Source on mounting base eliminates DC isolators, reducing common mode inductance
- Designed for broadband operation (HF to 2.2 GHz).

APPLICATIONS

• Communication transmitter applications in the UHF frequency range.

DESCRIPTION

Silicon N-channel enhancement mode lateral D-MOS transistor encapsulated in a 2-lead flange package (SOT467C) with a ceramic cap. The common source is connected to the mounting flange.

QUICK REFERENCE DATA

RF performance at $T_h = 25$ °C in a common source test circuit.

| MODE OF OPERATION (MHz) | | V _{DS} | P _L | G _p | η _D | d _{im} |
|-------------------------|--|-----------------|----------------|----------------|----------------|-----------------|
| | | (V) | (W) | (dB) | (%) | (dBc) |
| CW, class-AB (2-tone) | f ₁ = 2200; f ₂ = 2200.1 | 26 | 10 (PEP) | >11 | >30 | ≤–26 |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | | MAX. | UNIT |
|------------------|----------------------|-----|------|------|
| V _{DS} | drain-source voltage | _ | 65 | V |
| V _{GS} | gate-source voltage | - | ±15 | V |
| I _D | drain current (DC) | - | 2.2 | А |
| T _{stg} | storage temperature | -65 | +150 | °C |
| Tj | junction temperature | _ | 200 | °C |

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

PINNING - SOT467C

| PIN | DESCRIPTION |
|-----|-----------------------------|
| 1 | drain |
| 2 | gate |
| 3 | source, connected to flange |

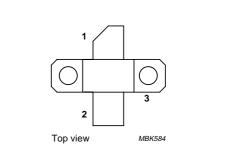


Fig.1 Simplified outline.

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|---------------------------------|-------|------|
| R _{th j-mb} | thermal resistance from junction to mounting base | T _{mb} = 25 °C; note 1 | 5 | K/W |
| R _{th mb-h} | thermal resistance from mounting base to heatsink | | 0.5 | K/W |

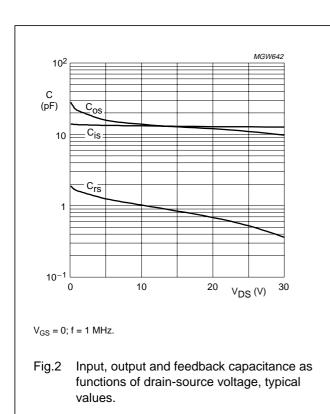
Note

1. Thermal resistance is determined under RF operating conditions.

CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|----------------------------------|---|------|------|------|------|
| V _{(BR)DSS} | drain-source breakdown voltage | $V_{GS} = 0; I_D = 0.2 \text{ mA}$ | 75 | - | - | V |
| V _{GSth} | gate-source threshold voltage | $V_{DS} = 10 \text{ V}; I_D = 20 \text{ mA}$ | 4 | - | 5 | V |
| I _{DSS} | drain-source leakage current | $V_{GS} = 0; V_{DS} = 26 V$ | - | - | 1.5 | μA |
| I _{DSX} | on-state drain current | $V_{GS} = V_{GSth} + 9 V; V_{DS} = 10 V$ | 2.8 | - | - | A |
| I _{GSS} | gate leakage current | $V_{GS} = \pm 15 \text{ V}; V_{DS} = 0$ | - | - | 40 | nA |
| g _{fs} | forward transconductance | V _{DS} = 10 V; I _D = 0.75 A | - | 0.5 | - | S |
| R _{DSon} | drain-source on-state resistance | V _{GS} = 10 V; I _D = 0.75 A | - | 1.2 | - | Ω |
| C _{is} | input capacitance | $V_{GS} = 0; V_{DS} = 26 V; f = 1 MHz$ | - | 13 | - | pF |
| C _{os} | output capacitance | $V_{GS} = 0; V_{DS} = 26 V; f = 1 MHz$ | - | 11 | - | pF |
| C _{rs} | feedback capacitance | $V_{GS} = 0; V_{DS} = 26 V; f = 1 MHz$ | - | 0.5 | - | pF |



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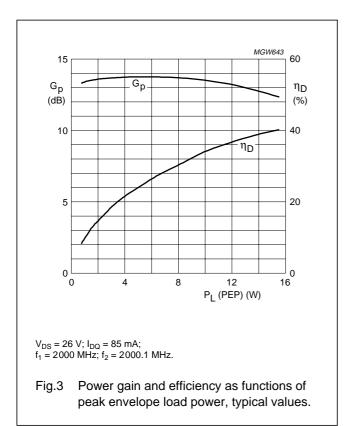
APPLICATION INFORMATION

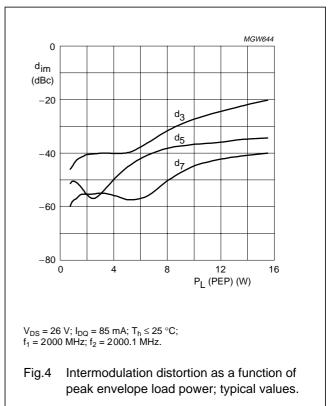
RF performance in a common source class-AB circuit. T_h = 25 °C; R_{th mb-h} = 0.4 K/W; unless otherwise specified.

| MODE OF OPERATION | f | V _{DS} | I _{DQ} | P _L | G _p | ղը | d _{im} |
|-----------------------|--|-----------------|-----------------|----------------|----------------|------------|-----------------|
| | (MHz) | (V) | (mA) | (W) | (dB) | (%) | (dBc) |
| CW, class-AB (2-tone) | f ₁ = 2200; f ₂ = 2200.1 | 26 | 85 | 10 (PEP) | >11 | >30 | ≤–26 |

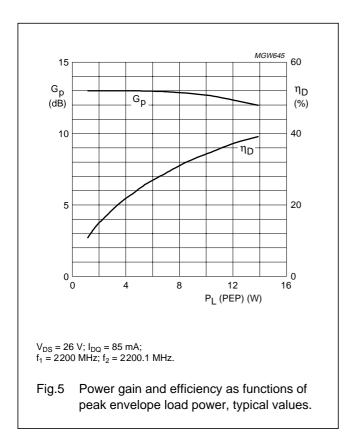
Ruggedness in class-AB operation

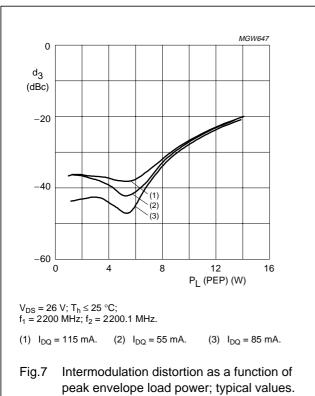
The BLF2043F is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 26 V; f = 2200 MHz at rated load power.





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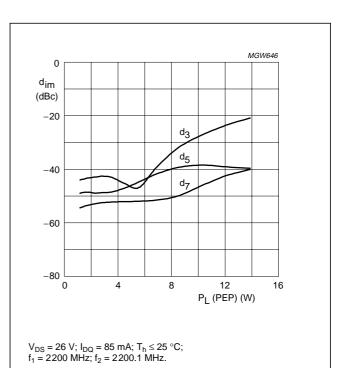
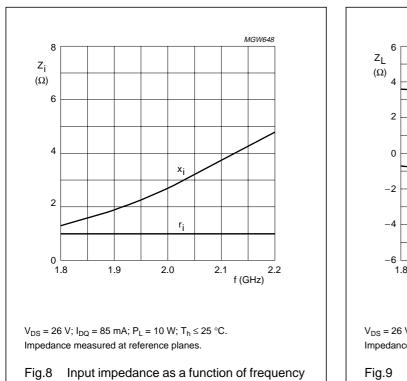
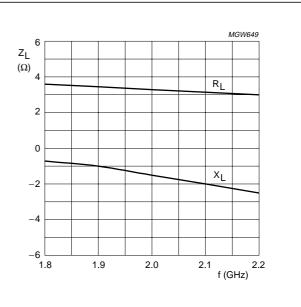


Fig.6 Intermodulation distortion as a function of peak envelope load power; typical values.

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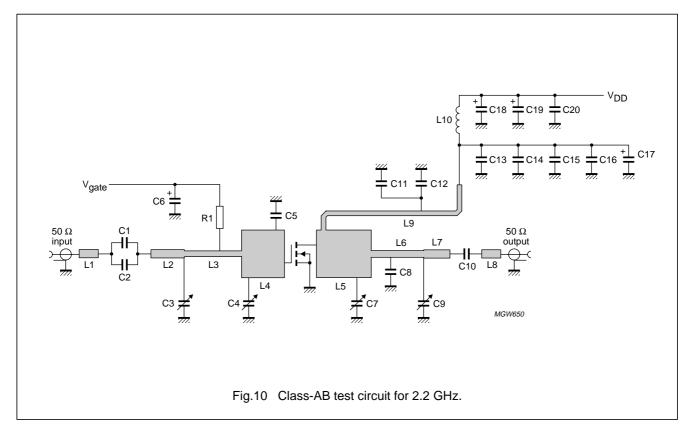


(series components); typical values.



 V_{DS} = 26 V; I_{DQ} = 85 mA; P_L = 10 W; $T_h \le$ 25 °C. Impedance measured at reference planes.

Fig.9 Load impedance as a function of frequency (series components); typical values.



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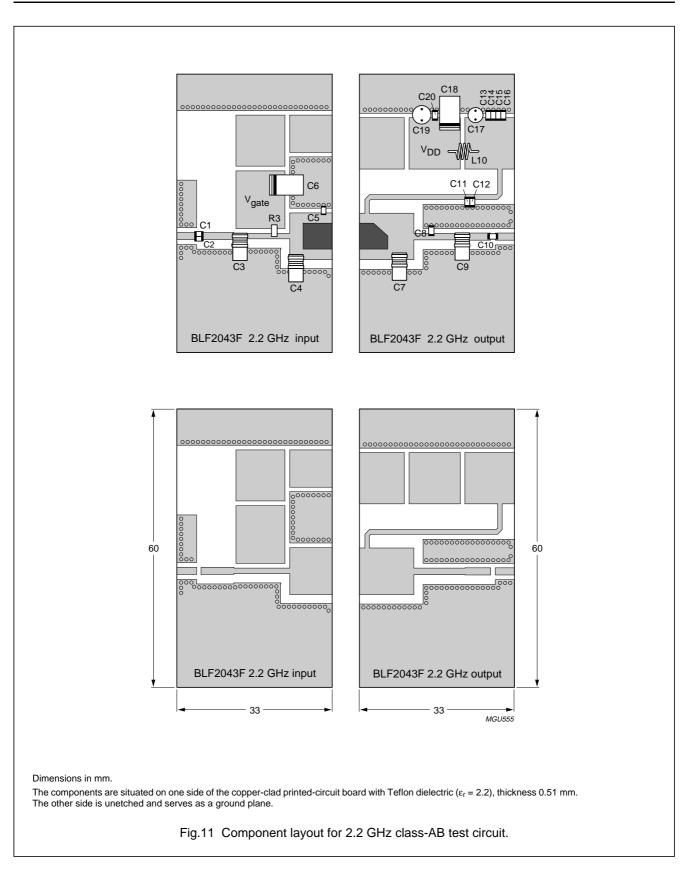
| | (see Figs 10 and 11) | | 1 | 1 |
|------------------|---|---------------|------------------------------------|----------------|
| COMPONENT | DESCRIPTION | VALUE | DIMENSIONS | CATALOGUE NO. |
| C1, C2, C10, C11 | multilayer ceramic chip capacitor; note 1 | 6.8 pF | | |
| C3, C4, C7, C9 | Tekelec variable capacitor; type 37271 | 0.6 to 4.5 pF | | |
| C5 | multilayer ceramic chip capacitor; note 1 | 2.4 pF | | |
| C6, C18 | tantalum SMD capacitor | 10 μF; 35 V | | |
| C8 | multilayer ceramic chip capacitor; note 1 | 1.5 pF | | |
| C12, C20 | multilayer ceramic chip capacitor; note 2 | 1 nF | | |
| C13 | multilayer ceramic chip capacitor; note 1 | 10 pF | | |
| C14 | multilayer ceramic chip capacitor; note 1 | 51 pF | | |
| C15 | multilayer ceramic chip capacitor; note 1 | 120 pF | | |
| C16 | multilayer ceramic chip capacitor | 100 nF | | 2222 581 16641 |
| C17 | electrolytic capacitor | 47 μF; 35 V | | 2222 036 90094 |
| C19 | electrolytic capacitor | 100 μF; 63 V | | 2222 037 58101 |
| L1, L8 | stripline; note 3 | 50 Ω | $4 \times 1.5 \text{ mm}$ | |
| L2 | stripline; note 3 | 50 Ω | $7 \times 1.5 \text{ mm}$ | |
| L3 | stripline; note 3 | 58.1 Ω | $12 \times 1.2 \text{ mm}$ | |
| L4 | stripline; note 3 | 11.3 Ω | $9 \times 10 \text{ mm}$ | |
| L5 | stripline; note 3 | 11.3 Ω | 11.5 × 10 mm | |
| L6 | stripline; note 3 | 52.8 Ω | $11 \times 1.4 \text{ mm}$ | |
| L7 | stripline; note 3 | 50 Ω | 5.5 	imes 1.5 mm | |
| L9 | stripline; note 3 | 64.7 Ω | $38 \times 1 \text{ mm}$ | |
| L10 | 2 turns enamelled 0.5 mm copper wire | | int. dia. = 3 mm; length = 3 mm | |
| R1 | metal film resistor | 390 Ω; 0.6 W | | 2322 156 11009 |

List of components (see Figs 10 and 11)

Notes

- 1. American Technical Ceramics type 100A or capacitor of same quality.
- 2. American Technical Ceramics type 100B or capacitor of same quality.
- 3. The striplines are on a double copper-clad printed-circuit board with Rogers 5880 dielectric (ϵ_r = 2.2); thickness 0.51 mm.

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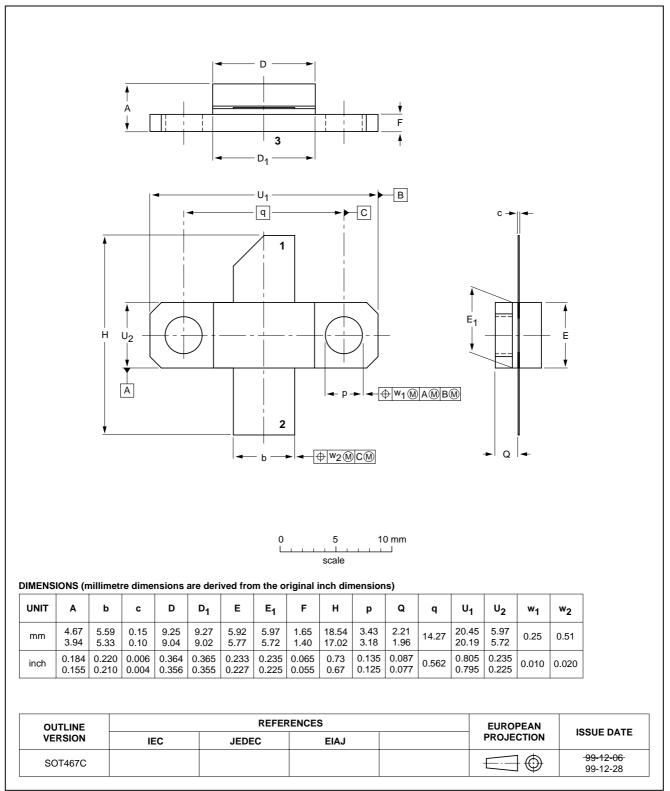


BLF2043F

UHF power LDMOS transistor

PACKAGE OUTLINE

Flanged LDMOST ceramic package; 2 mounting holes; 2 leads



SOT467C

BLF2043F

DATA SHEET STATUS

| DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITIONS |
|----------------------------------|----------------------------------|--|
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